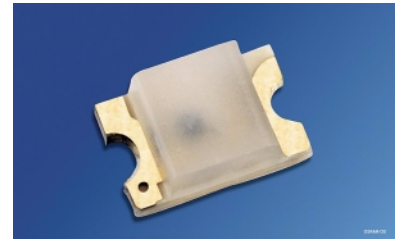


## CHIPLED

### LO R971, LY R971



#### Besondere Merkmale

- **Gehäusetyp:** 0805
- **Besonderheit des Bauteils:** extrem kleine Bauform 2,0 mm x 1,25 mm x 0,8 mm
- **Wellenlänge:** 590 nm (gelb), 605 nm (orange)
- **Abstrahlwinkel:** extrem breite Abstrahlcharakteristik (160°)
- **Technologie:** GaAsP (gelb, orange)
- **optischer Wirkungsgrad:** 1,5 lm/W (gelb), 1,5 lm/W (orange)
- **Verarbeitungsmethode:** für alle SMT-Bestücktechniken geeignet
- **Lötmethode:** IR Reflow Löten
- **Vorbehandlung:** nach JEDEC Level 2
- **Gurtung:** 8 mm Gurt mit 4000/Rolle, ø180 mm

#### Anwendungen

- Informationsanzeigen im Innenbereich
- optischer Indikator
- Flache Hinterleuchtung (LCD, Handy, Schalter, Display)
- Spielsachen

#### Features

- **package:** 0805
- **feature of the device:** extremely small package 2.0 mm x 1.25 mm x 0.8 mm
- **wavelength:** 590 nm (yellow), 605 nm (orange)
- **viewing angle:** extremely wide (160°)
- **technology:** GaAsP (yellow, orange)
- **optical efficiency:** 1.5 lm/W (yellow), 1.5 lm/W (orange)
- **assembly methods:** suitable for all SMT assembly methods
- **soldering methods:** IR reflow soldering
- **preconditioning:** acc. to JEDEC Level 2
- **taping:** 8 mm tape with 4000/reel, ø180 mm

#### Applications

- indoor displays
- optical indicators
- flat backlighting (LCD, cellular phones, switches, displays)
- toys

Typ Type	Emissionsfarbe Color of Emission	Farbe der Lichtaustrittsfläche Color of the Light Emitting Area	Lichtstärke Luminous Intensity $I_F = 20 \text{ mA}$ $I_V \text{ (mcd)}$		Bestellnummer Ordering Code
			min.	typ.	
LO R971	orange	colorless diffused	2.8	6	Q62702-P5180
LY R971	yellow	colorless diffused	2.8	6	Q62702-P5181

Helligkeitswerte werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von  $\pm 11 \%$  ermittelt.  
Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of  $\pm 11 \%$ .

*Anm.: Die Standardlieferform von Serientypen beinhaltet eine untere bzw. eine obere Familiengruppe, die aus nur 3 bzw. 4 Halbgruppen besteht. Einzelne Halbgruppen sind nicht erhältlich.  
In einer Verpackungseinheit / Gurt ist immer nur eine Halbgruppe enthalten.*

*Note: The standard shipping format for serial types includes a lower or upper family group of 3 or 4 individual groups. Individual half groups are not available.  
No packing unit / tape ever contains more than one luminous intensity group.*

**Grenzwerte**  
**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebstemperatur Operating temperature range	$T_{op}$	- 30 ... + 85	°C
Lagertemperatur Storage temperature range	$T_{stg}$	- 40 ... + 85	°C
Sperrschichttemperatur Junction temperature	$T_j$	+ 95	°C
Durchlassstrom Forward current	$I_F$	25 (orange) 20 (yellow)	mA
Stoßstrom Surge current $t_p = 10 \mu s, D = 0.1$	$I_{FM}$	0.1	A
Sperrspannung Reverse voltage	$V_R$	5	V
Leistungsaufnahme Power consumption	$P_{tot}$	65	mW
Wärmewiderstand Thermal resistance Sperrschicht/Umgebung Junction/ambient	$R_{th JA}$	800	K/W
Sperrschicht/Lötpad Junction/solder point Montage auf PC-Board FR 4 (Padgröße $\geq 16 \text{ mm}^2$ ) mounted on PC board FR 4 (pad size $\geq 16 \text{ mm}^2$ )	$R_{th JS}$	450	K/W

**Kennwerte** ( $T_A = 25\text{ °C}$ )

**Characteristics**

Bezeichnung Parameter	Symbol Symbol	Werte Values		Einheit Unit
		LO	LY	
Wellenlänge des emittierten Lichtes (typ.) Wavelength at peak emission $I_F = 20\text{ mA}$	$\lambda_{\text{peak}}$	610	589	nm
Dominantwellenlänge <sup>1)</sup> (typ.) Dominant wavelength <sup>1)</sup> $I_F = 20\text{ mA}$	$\lambda_{\text{dom}}$	605	590	nm
Spektrale Bandbreite (typ.) Spectral bandwidth $I_F = 20\text{ mA}$	$\Delta\lambda$	35	40	nm
Abstrahlwinkel bei 50 % $I_V$ (Vollwinkel) (typ.) Viewing angle at 50 % $I_V$	$2\phi$	160	160	Grad deg.
Durchlassspannung <sup>2)</sup> (typ.) Forward voltage <sup>2)</sup> $I_F = 20\text{ mA}$	$V_F$ $V_F$	2.1 2.5	2.2 2.5	V V
Sperrstrom (typ.) Reverse current (max.) $V_R = 5\text{ V}$	$I_R$ $I_R$	0.02 100	0.02 100	$\mu\text{A}$ $\mu\text{A}$
Temperaturkoeffizient von $\lambda_{\text{peak}}$ (typ.) Temperature coefficient of $\lambda_{\text{peak}}$ $I_F = 20\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_{\lambda_{\text{peak}}}$	0.11	0.11	nm/K
Temperaturkoeffizient von $\lambda_{\text{dom}}$ (typ.) Temperature coefficient of $\lambda_{\text{dom}}$ $I_F = 20\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_{\lambda_{\text{dom}}}$	0.06	0.08	nm/K
Temperaturkoeffizient von $V_F$ (typ.) Temperature coefficient of $V_F$ $I_F = 20\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_V$	- 1.6	- 1.7	mV/K
Optischer Wirkungsgrad (typ.) Optical efficiency $I_F = 20\text{ mA}$	$\eta_{\text{opt}}$	1.5	1.5	lm/W

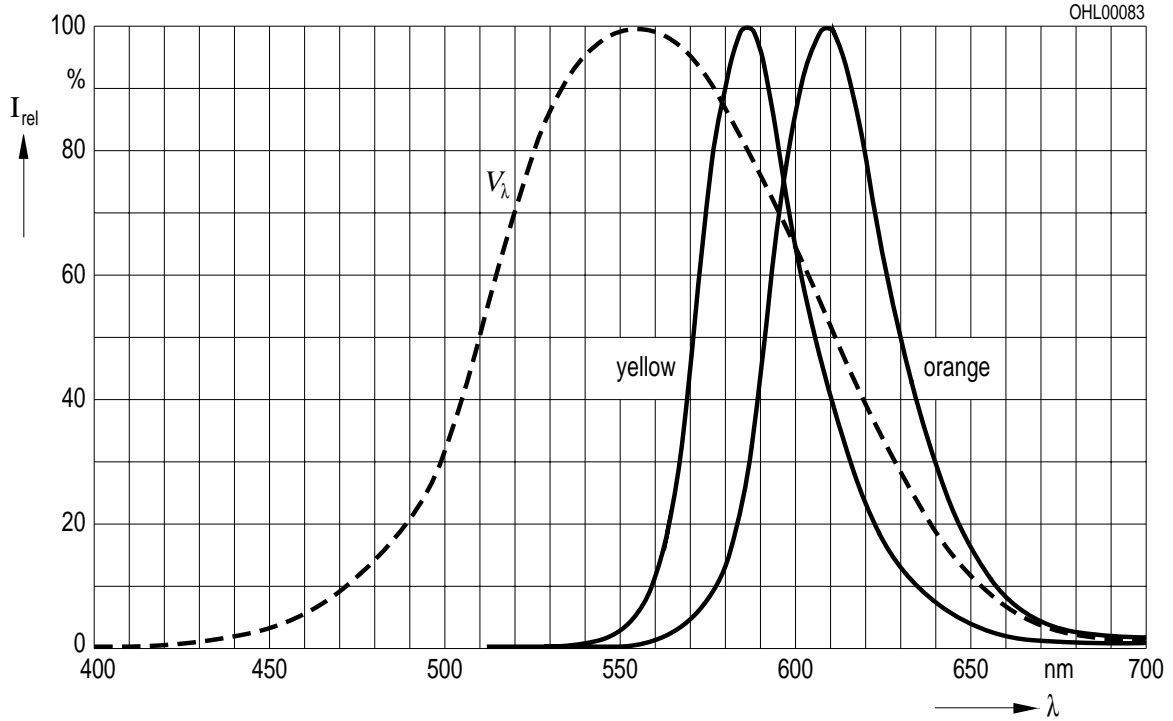
<sup>1)</sup> Wellenlängengruppen werden mit einer Stromeinprägungsdauer von 25 ms und einer Genauigkeit von  $\pm 1\text{ nm}$  ermittelt.  
Wavelength groups are tested at a current pulse duration of 25 ms and an accuracy of  $\pm 1\text{ nm}$ .

<sup>2)</sup> Spannungswerte werden mit einer Stromeinprägungsdauer von 1 ms und einer Genauigkeit von  $\pm 0,1\text{ V}$  ermittelt.  
Voltages are tested at a current pulse duration of 1 ms and an accuracy of  $\pm 0.1\text{ V}$ .

Relative spektrale Emission  $I_{rel} = f(\lambda)$ ,  $T_A = 25\text{ °C}$ ,  $I_F = 20\text{ mA}$

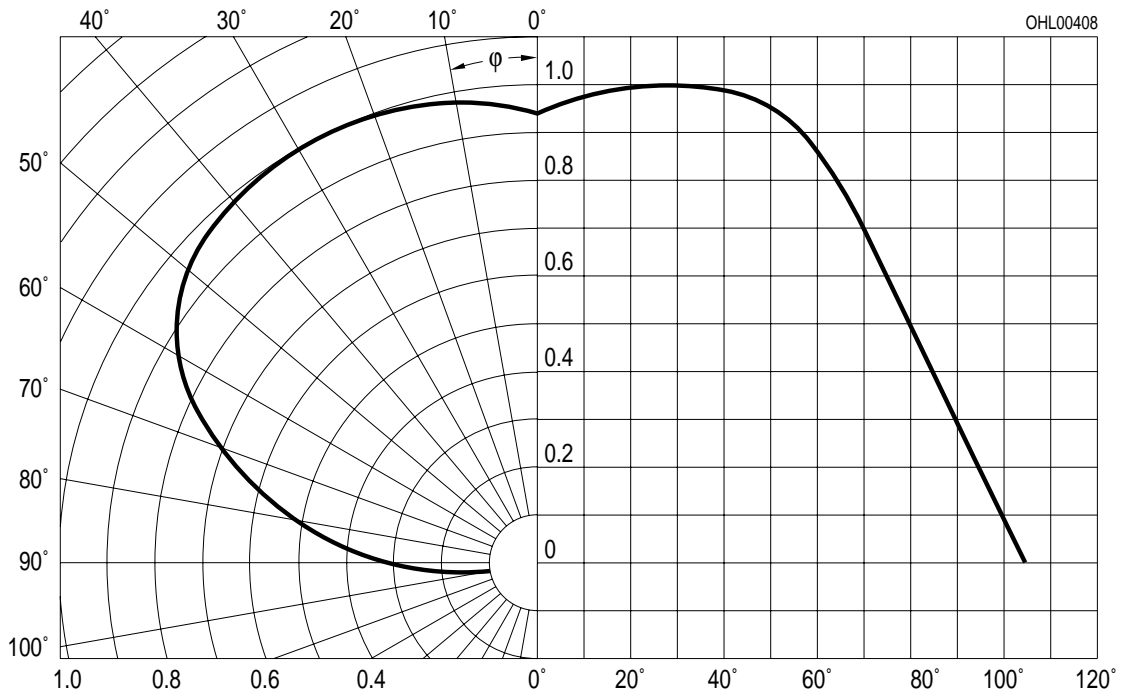
**Relative Spectral Emission**

$V(\lambda)$  = spektrale Augenempfindlichkeit  
Standard eye response curve



Abstrahlcharakteristik  $I_{rel} = f(\varphi)$

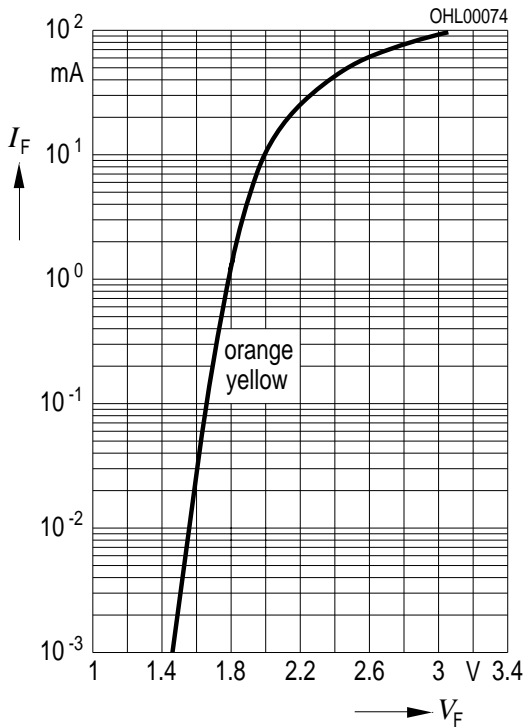
**Radiation Characteristic**



**Durchlassstrom  $I_F = f(V_F)$**

**Forward Current**

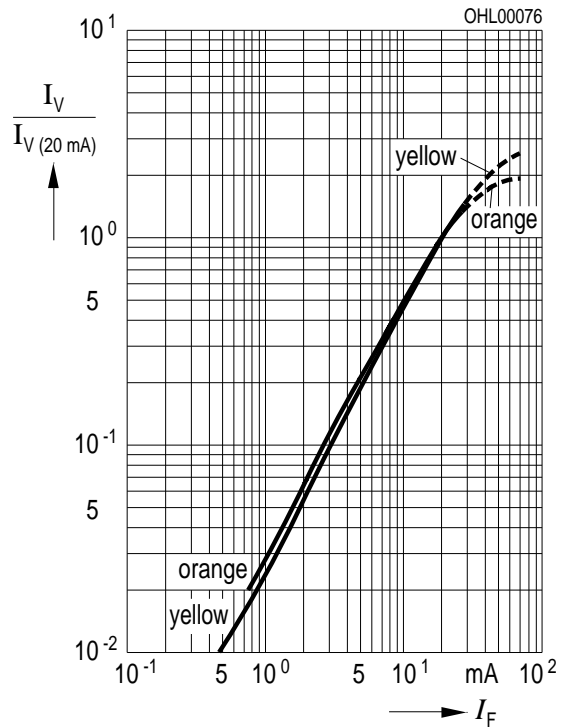
$T_A = 25\text{ }^\circ\text{C}$



**Relative Lichtstärke  $I_V/I_{V(20\text{ mA})} = f(I_F)$**

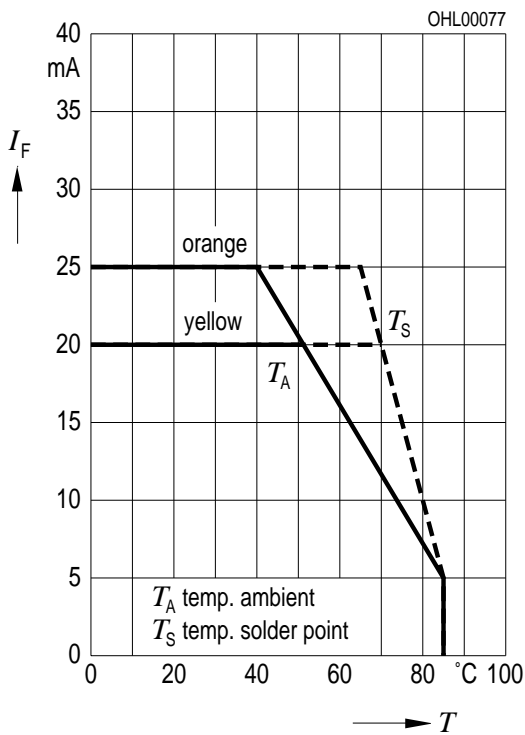
**Relative Luminous Intensity**

$T_A = 25\text{ }^\circ\text{C}$



**Maximal zulässiger Durchlassstrom  $I_F = f(T_A)$**

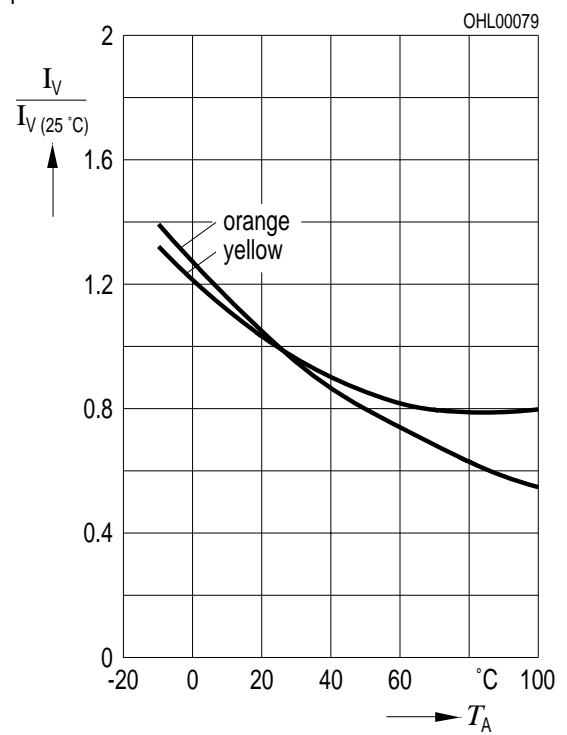
**Max. Permissible Forward Current**



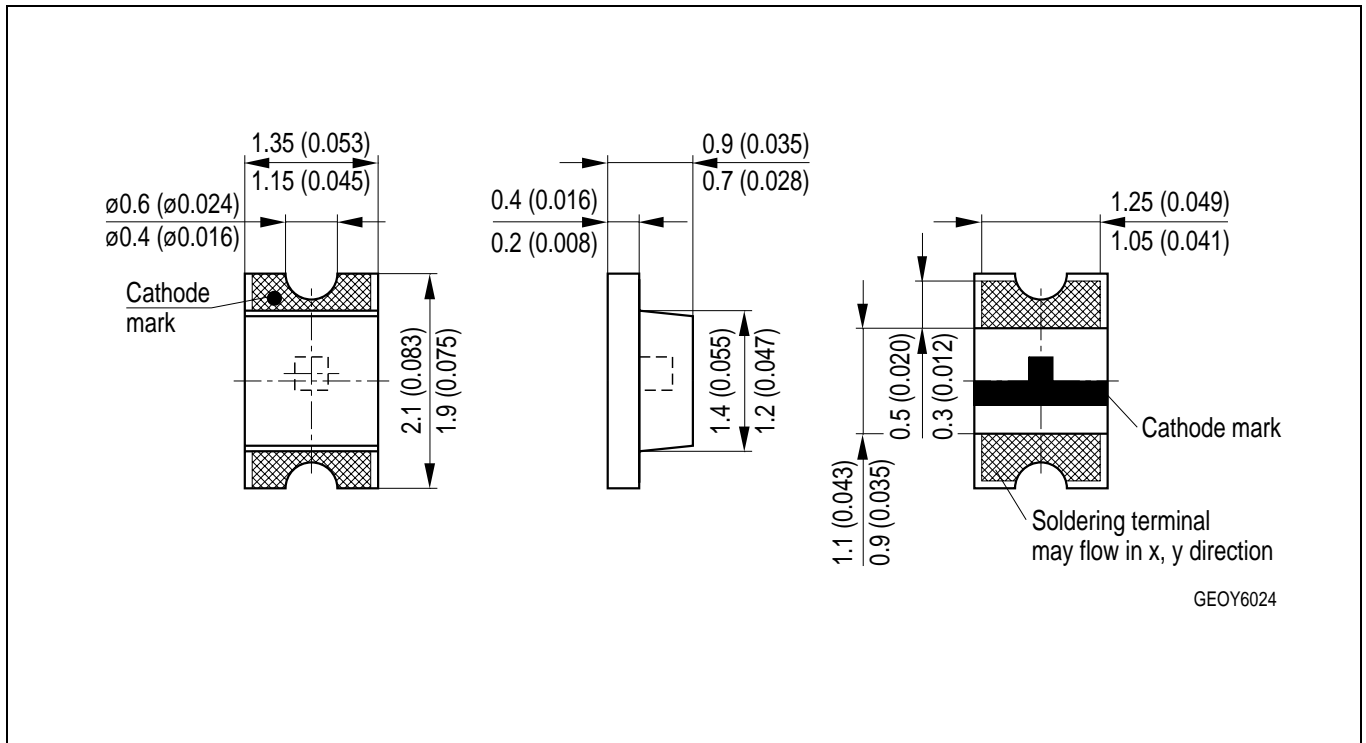
**Relative Lichtstärke  $I_V/I_{V(25\text{ }^\circ\text{C})} = f(T_A)$**

**Relative Luminous Intensity**

$I_F = 20\text{ mA}$



**Maßzeichnung**  
**Package Outlines**

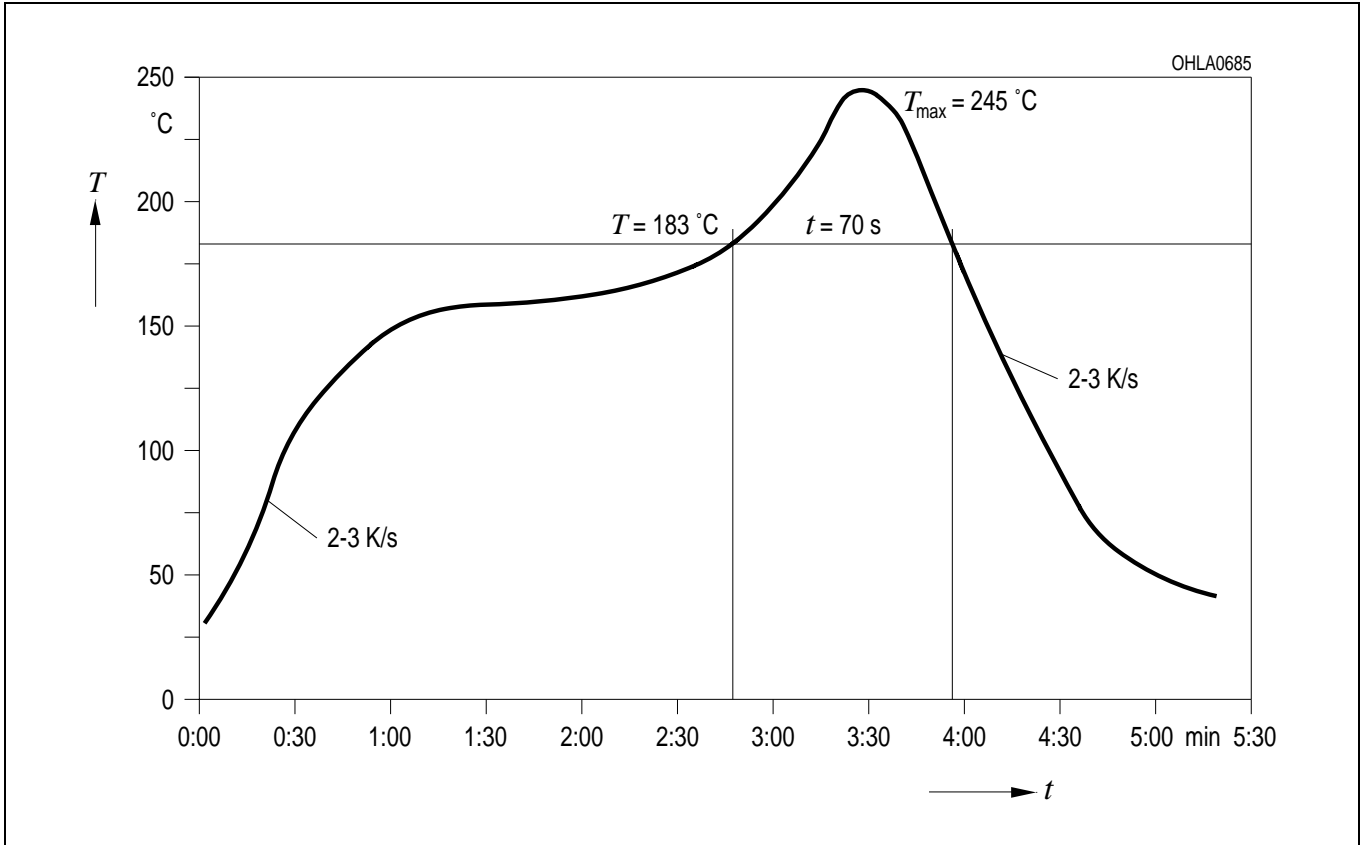


Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

**Gewicht / Approx. weight:** 3.2 mg

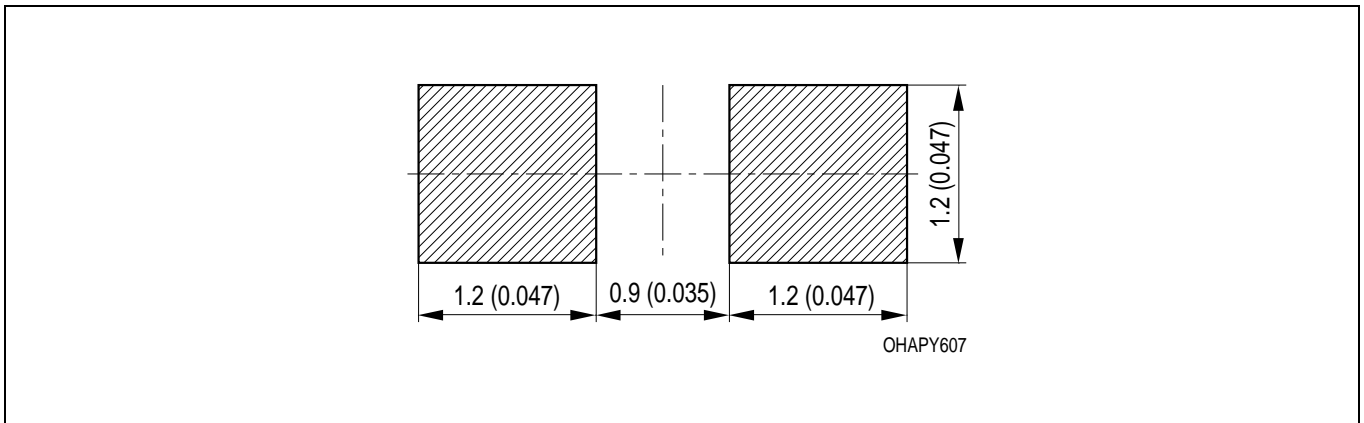
**Lötbedingungen** Vorbehandlung nach JEDEC Level 2  
**Soldering Conditions** Preconditioning acc. to JEDEC Level 2

**IR-Reflow Lötprofil** (nach IPC 9501)  
**IR Reflow Soldering Profile** (acc. to IPC 9501)



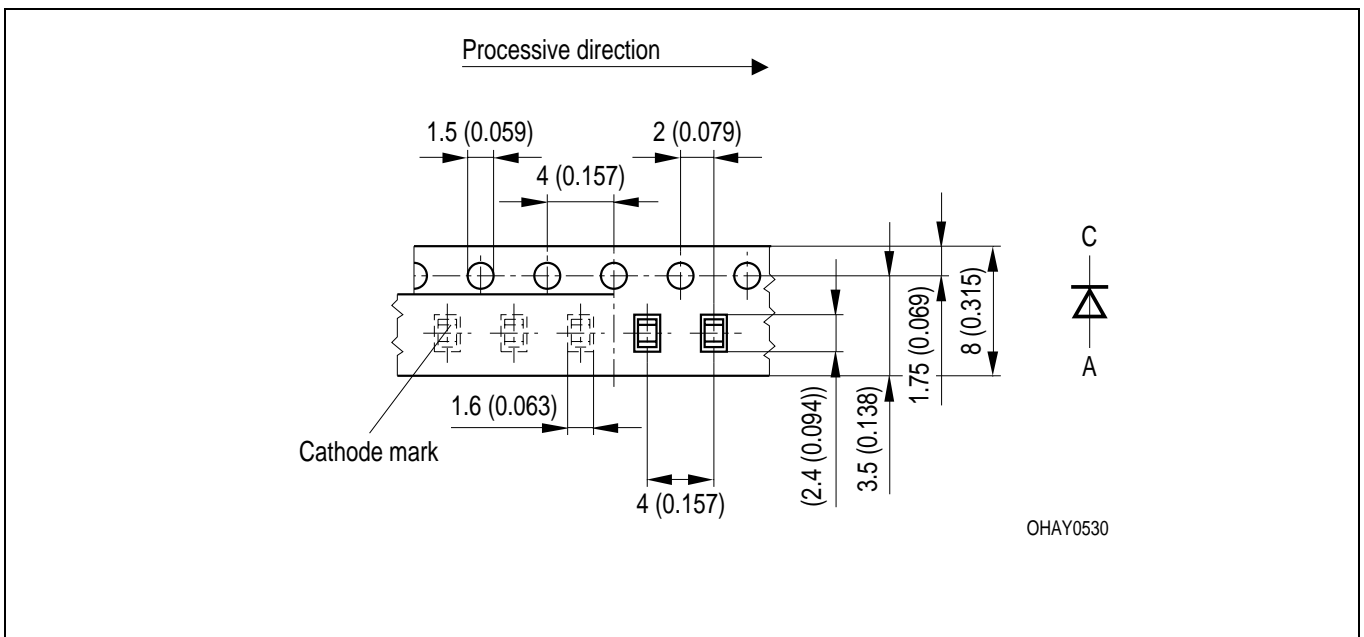


**Empfohlenes Lötpaddingesign** IR Reflow Löten  
**Recommended Solder Pad** IR Reflow Soldering



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

**Gurtung / Polarität und Lage** Verpackungseinheit 4000/Rolle, ø180 mm  
**Method of Taping / Polarity and Orientation** Packing unit 4000/reel, ø180 mm



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

**Revision History: 2001-03-05**

Previous Version: 2001-03-05

Page	Subjects (major changes since last revision)

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